

 $1.6 \times 0.8 \times 0.5$ mm Bi-Color Surface Mount LED

Features

• 1.6mm x 0.8mm SMD LED

• Package height: 0.5mm

ullet IR-reflow compatible

 \bullet Standard Package: 2,000pcs/ Reel

• MSL (Moisture Sensitivity Level): 3

 \bullet Halogen-free

• RoHS compliant

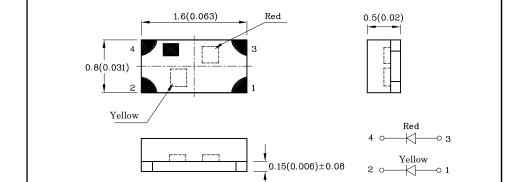


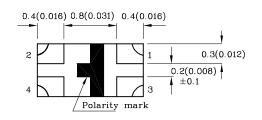




ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE

DEVICES





Notes:

1. All dimensions are in millimeters (inches).

Package Schematics

- 2. Tolerance is $\pm 0.15(0.006")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		Yellow (AlGaInP)	Red (AlGaInP)	Unit
Reverse Voltage	V_{R}	5	5	V
Forward Current	I_{F}	30	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	175	185	mA
Power Dissipation	P_D	75	75	mW
Operating Temperature	$T_{\rm A}$	-40 ~ +85		°C
Storage Temperature	Tstg	-40 ~ +85		C

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Yellow (AlGaInP)	Red (AlGaInP)	Unit
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	2	1.95	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.5	2.5	V
Reverse Current (Max.) $(V_R=5V)$	I_{R}	10	10	μA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =20mA)	λP	590*	645*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =20mA)	λD	590*	630*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	Δλ	20	28	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	20	35	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I _F =20mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZMYKMDK53W-9	Yellow	AlGaInP	Water Clear	80 80*	148 148*	590*	130°
	Red	AlGaInP		120 40*	248 89*	645*	

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

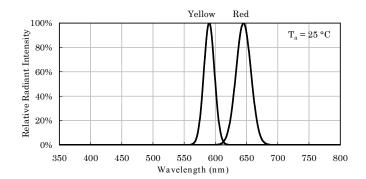
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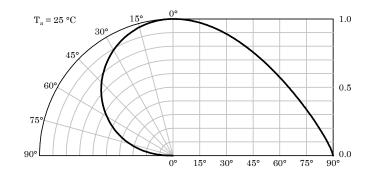


1.6 x 0.8 x 0.5 mm Bi-Color Surface Mount LED



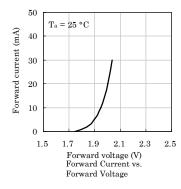


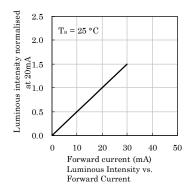
Relative Intensity Vs. CIE Wavelength

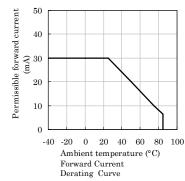


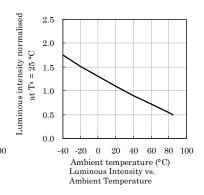
Spatial Distribution

❖ Yellow

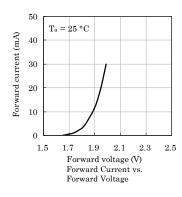


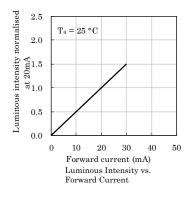


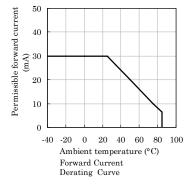


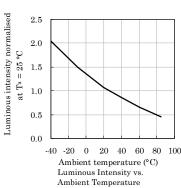


❖ Red







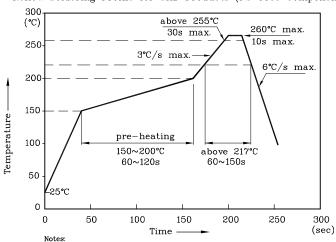






LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

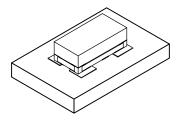


- 1. All temperatures refer to the center of the package, measured on the package body surface facing up during reflow.
- 2. Do not apply any stress to the LED during high temperature conditions. 3. Maximum number of soldering passes: 2

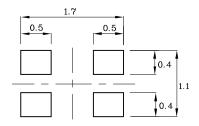
TAPE

 4 ± 0.1

❖ The device has a single mounting surface. The device must be mounted according to the specifications.



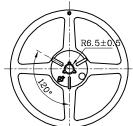
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



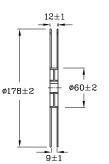
❖ Tape Specification (Units:mm)

4±0.1





❖ Reel Dimension (Units: mm)



Remarks:

8±0.3

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

 0.75 ± 0.1

0.254±0.1

 $\phi 1.5 \pm 0.1$

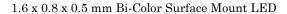
1. Wavelength: +/-1nm

1.75±0.1

 3.5 ± 0.05

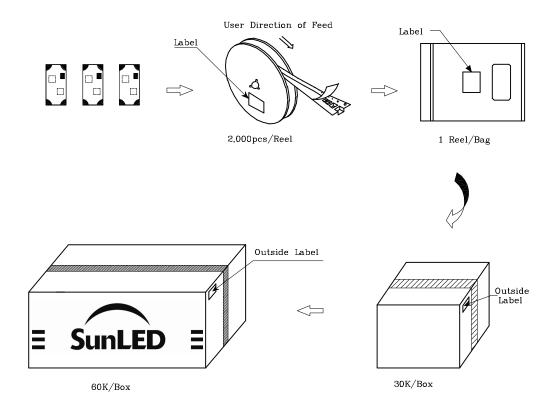
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

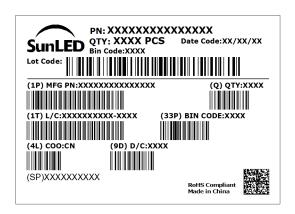
Note: Accuracy may depend on the sorting parameters.





PACKING & LABEL SPECIFICATIONS





TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
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- 6. Additional technical notes are available at https://www.SunLEDusa.com/TechnicalNotes.asp

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